

Function	Unit Base	Rate \$
SAMPLE PREP ROOM ACCESS	hr	5
CLEANROOM ACCESS [10 hr min]	hr	2
THERMAL PROCESSES	hr	4
AFM	hr	8
LOW RESOLUTION SEM	hr	9
SEM	hr	43
EDS	hr	19
TEM	hr	53
XRD	hr	19
DSC	hr	22
SDT	hr	20
FIB	hr	43
Ebeam Lithography	hr	55
Photolithography [1 hr. min]	hr	7
Laser Lithography UPG101	hr	9
Parylene Coating	hr	9
RIE [1 hr. min]	hr	10
Ashing	hr	3
PVD; Sputtering [base metals]	hr	20
PVD; Evaporation [base metals]	hr	13
RTA [1 hr. min]	hr	5
Microscopy sample coating [Au]	per cycle(3 min cycle)	8
Microscopy sample coating [C]	per cycle(3 min cycle)	7
Screen printer	hr	11
Wedge Bonder	hr	14
Cutting Laser	hr	23
Training	hr	28
Engineering Services	hr	30
Analytical Services	hr	43
Additive Manufacturing	hr	38
Tool Operation/Gen. Labor	hr	36
MTS Tensile Tester	hr	26
Nano Indenter	hr	38
Omniprobe	hr	27
PECVD	hr	39